

SEMICONDUCTOR

MMPQ2222

NPN Multi-Chip General Purpose Amplifier

- This device is for use as a medium power amplifier and switch requiring collector currents up to 500mA.
- Sourced from process 19.



Absolute Maximum Ratings * T_a=25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V _{CEO}	Collector-Emitter Voltage	30	V	
V _{CBO}	Collector-Base Voltage	60	V	
V _{EBO}	Emitter-Base Voltage	5.0	V	
I _C	Collector Current - Continuous	500	mA	
T _J , T _{STG}	Operating and Storage Junction Temperature Range	- 55 ~ +155	°C	

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired

NOTES:

1) These ratings are based on a maximum junction temperature of 150 degrees C.
2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations

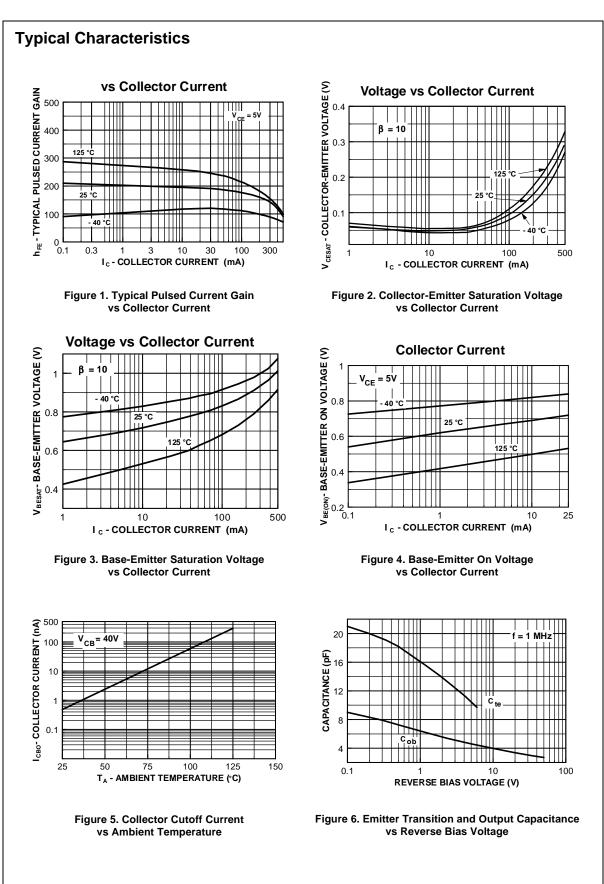
Electrical Characteristics T_a=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Charact	eristics	•		•	
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage *	$I_{\rm C} = 10 {\rm mA}, I_{\rm B} = 0$	30		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_{\rm C} = 10 \mu {\rm A}, \ I_{\rm E} = 0$	60		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_{\rm C} = 10 \mu {\rm A}, \ I_{\rm C} = 0$	5.0		V
I _{CBO}	Collector Cutoff Current	$V_{CB} = 50V, I_E = 0$		50	nA
I _{EBO}	Emitter Cutoff Current	V_{EB} = 3.0V, I_{C} = 0		50	nA
On Charact	eristics *				
h _{FE}	DC Current Gain	$I_{C} = 10mA, V_{CE} = 10V$ $I_{C} = 150mA, V_{CE} = 1.0V *$ $I_{C} = 150mA, V_{CE} = 1.0V *$	75 100 50		
V _{CE(sat)}	Collector-Emitter Saturation Voltage *	I _C = 150mA, I _B = 15mA I _C = 500mA, I _B = 50mA		0.4 1.6	V V
V _{BE(sat)}	Base-Emitter Saturation Voltage *	$I_{C} = 150$ mA, $I_{B} = 15$ mA $I_{C} = 500$ mA, $I_{B} = 50$ mA		1.3 2.6	V V
Small Signa	I Characteristics	·			•
f _T	Current GAin Bandwidth Product	$I_{C} = 20$ mA, $V_{CE} = 20$ V, f = 100MHz		300	MHz
C _{obo}	Output Capacitance	$V_{CB} = 10V, I_E = 0, f = 100kHz$		4.0	pF
C _{ibo}	Input Capacitance	$V_{EB} = 0.5V, I_E = 0, f = 100 kHz$		20	pF
NF	Noise Figure	$I_{C} = 100\mu A, V_{CE} = 10V,$ $R_{S} = 1.0k\Omega, f = 1.0kHz$		2.0	dB

* Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2.0\%$

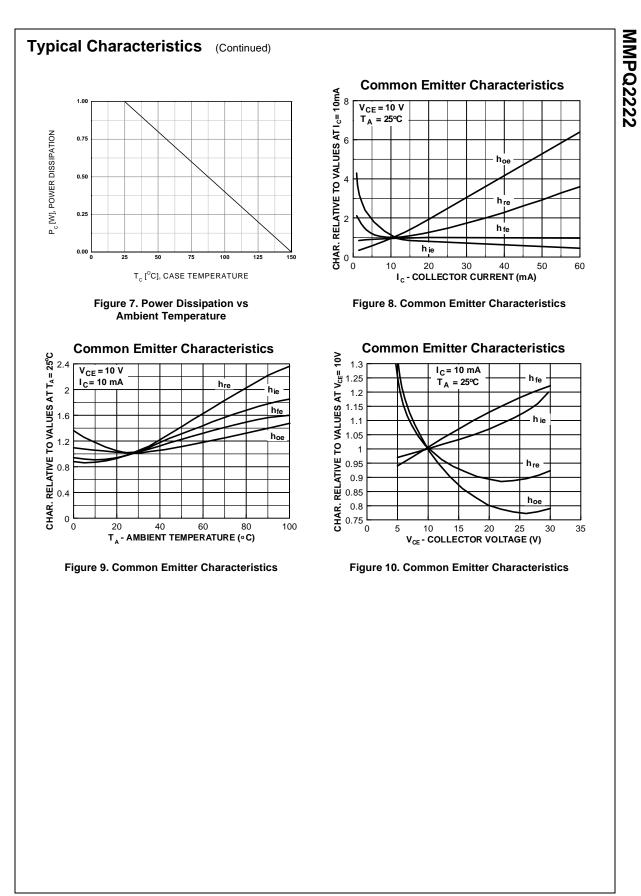
Thermal Characteristics T _a =25°C unless otherwise noted Symbol Parameter Max. Units					
P _D	Total Device Dissipation Derate above 25°C	1000 8.0	mW mW/°C		
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient Effective 4 Die Each Die	125 240	°C/W °C/W		

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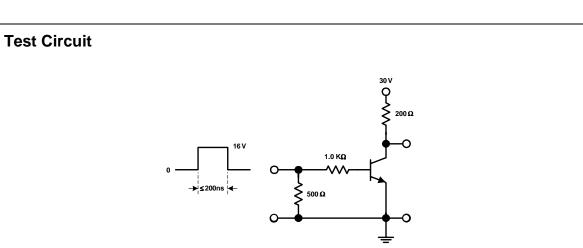
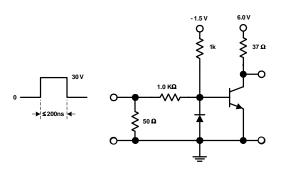
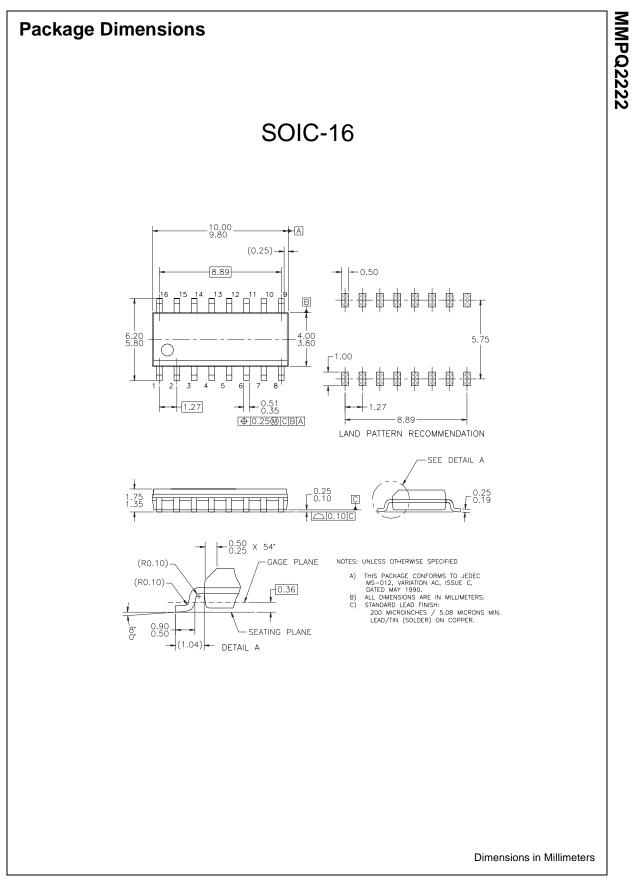


Figure 1. Saturated Turn-On Switching Time





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